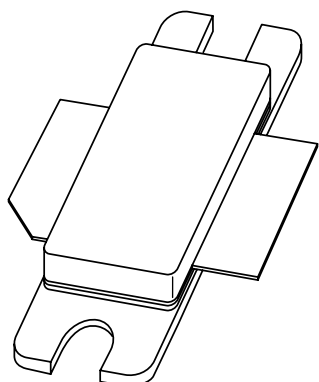


DATA SHEET



BLF1820-70 UHF power LDMOS transistor

Product specification
Supersedes data of 2001 Feb 12

2003 Feb 10

UHF power LDMOS transistor

BLF1820-70

FEATURES

- Typical 2-tone performance at a supply voltage of 26 V and I_{DQ} of 500 mA:
 - Output power = 65 W (PEP)
 - Gain = 12 dB
 - Efficiency = 32%
 - $dim = -26$ dBc
- Easy power control
- Excellent ruggedness
- High power gain
- Excellent thermal stability
- Designed for broadband operation (1800 to 2000 MHz)
- Internally matched for ease of use.

APPLICATIONS

- RF power amplifiers for GSM, EDGE and CDMA base stations and multicarrier applications in the 1800 to 2000 MHz frequency range.

DESCRIPTION

70 W LDMOS power transistor for base station applications at frequencies from 1800 to 2000 MHz.

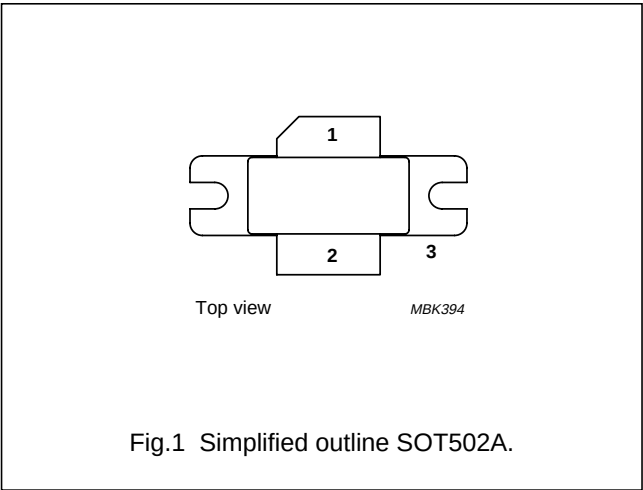
QUICK REFERENCE DATA

RF performance at $T_h = 25\text{ }^{\circ}\text{C}$ in a common source test circuit.

MODE OF OPERATION	f (MHz)	V _{DS} (V)	P _L (W)	G _p (dB)	η _D (%)	d _{im} (dBc)
2-tone, class-AB	f ₁ = 2000; f ₂ = 2000.1	26	65 (PEP)	>11	>30	≤−25

PINNING

PIN	DESCRIPTION
1	drain
2	gate
3	source, connected to flange



CAUTION

This product is supplied in anti-static packing to prevent damage caused by electrostatic discharge during transport and handling. For further information, refer to Philips specs.: SNW-EQ-608, SNW-FQ-302A and SNW-FQ-302B.

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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	MIN.	MAX.	UNIT
V_{DS}	drain-source voltage	–	65	V
V_{GS}	gate-source voltage	–	± 15	V
I_D	DC drain current	–	9	A
T_{stg}	storage temperature	–65	+150	°C
T_j	junction temperature	–	200	°C

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th\ j-h}$	thermal resistance from junction to heatsink	$T_h = 25\text{ °C}$, note 1	1.15	K/W

Note

1. Determined under specified RF operating conditions.

CHARACTERISTICS

$T_j = 25\text{ °C}$ unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{(BR)DSS}$	drain-source breakdown voltage	$V_{GS} = 0$; $I_D = 1.4\text{ mA}$	65	–	–	V
V_{GSth}	gate-source threshold voltage	$V_{DS} = 10\text{ V}$; $I_D = 140\text{ mA}$	4.4	–	5.5	V
I_{DSS}	drain-source leakage current	$V_{GS} = 0$; $V_{DS} = 26\text{ V}$	–	–	10	μA
I_{DSX}	on-state drain current	$V_{GS} = V_{GSth} + 9\text{ V}$; $V_{DS} = 10\text{ V}$	18	–	–	A
I_{GSS}	gate leakage current	$V_{GS} = \pm 15\text{ V}$; $V_{DS} = 0$	–	–	25	nA
g_{fs}	forward transconductance	$V_{DS} = 10\text{ V}$; $I_D = 5\text{ A}$	–	4.2	–	S
R_{DSon}	drain-source on-state resistance	$V_{GS} = V_{GSth} + 9\text{ V}$; $I_D = 5\text{ A}$	–	0.15	–	Ω
C_{rss}	feedback capacitance	$V_{GS} = 0$; $V_{DS} = 26\text{ V}$; $f = 1\text{ MHz}$	–	3.4	–	pF

APPLICATION INFORMATION

RF performance in a common source class-AB circuit. $T_h = 25\text{ °C}$; $R_{th\ j-h} = 1.15\text{ K/W}$, unless otherwise specified.

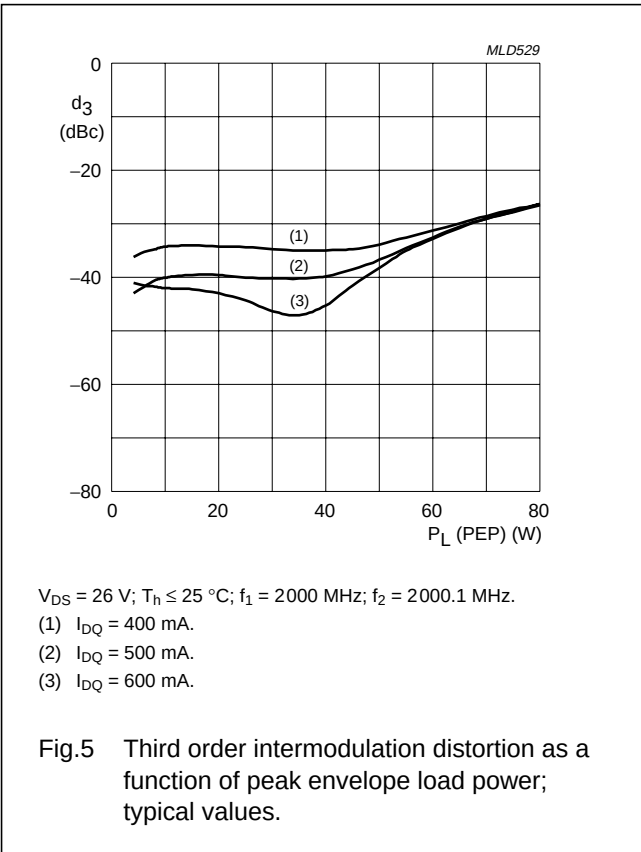
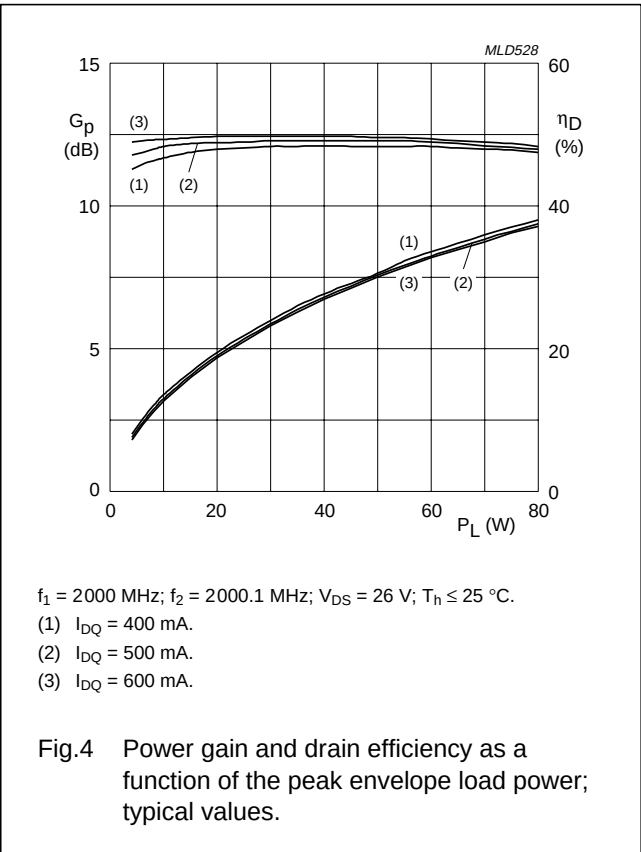
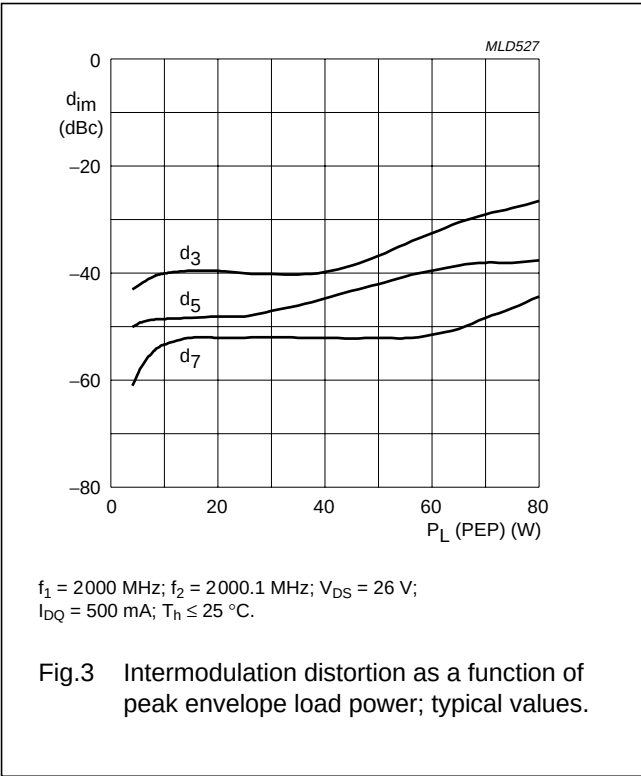
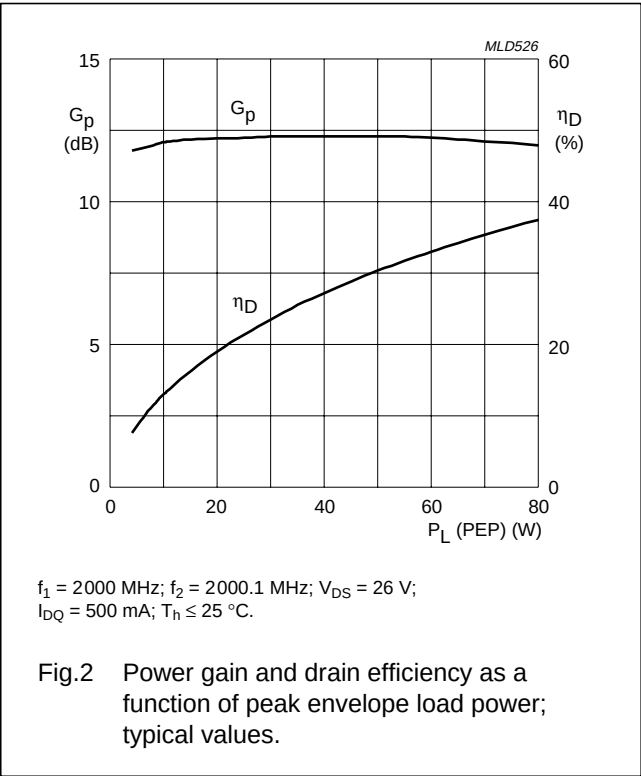
MODE OF OPERATION	f (MHz)	V_{DS} (V)	I_{DQ} (mA)	P_L (W)	G_p (dB)	η_D (%)	d_{im} (dBc)
2-tone, class-AB	$f_1 = 2000$; $f_2 = 2000.1$	26	500	65 (PEP)	>11	>30	≤ -25

Ruggedness in class-AB operation

The BLF1820-70 is capable of withstanding a load mismatch corresponding to $VSWR = 10 : 1$ through all phases under the following conditions: $V_{DS} = 26\text{ V}$; $I_{DQ} = 500\text{ mA}$; $P_L = 65\text{ W}$; $f = 2000\text{ MHz}$.

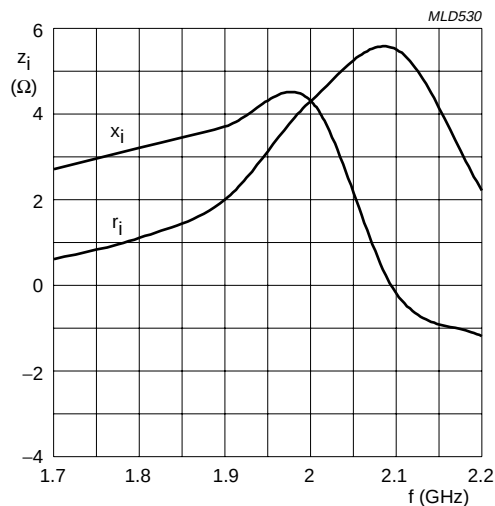
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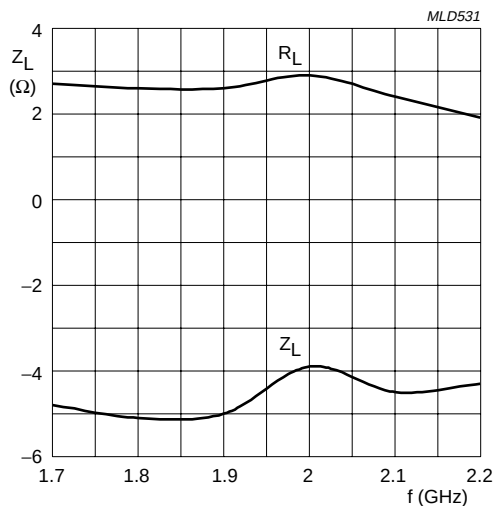
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$V_{DS} = 26\text{ V}$; $I_{DQ} = 500\text{ mA}$; $P_L = 65\text{ W}$; $T_h \leq 25\text{ }^\circ\text{C}$.

Fig.6 Input impedance as a function of frequency (series components); typical values.



$V_{DS} = 26\text{ V}$; $I_{DQ} = 500\text{ mA}$; $P_L = 65\text{ W}$; $T_h \leq 25\text{ }^\circ\text{C}$.

Fig.7 Load impedance as a function of frequency (series components); typical values.

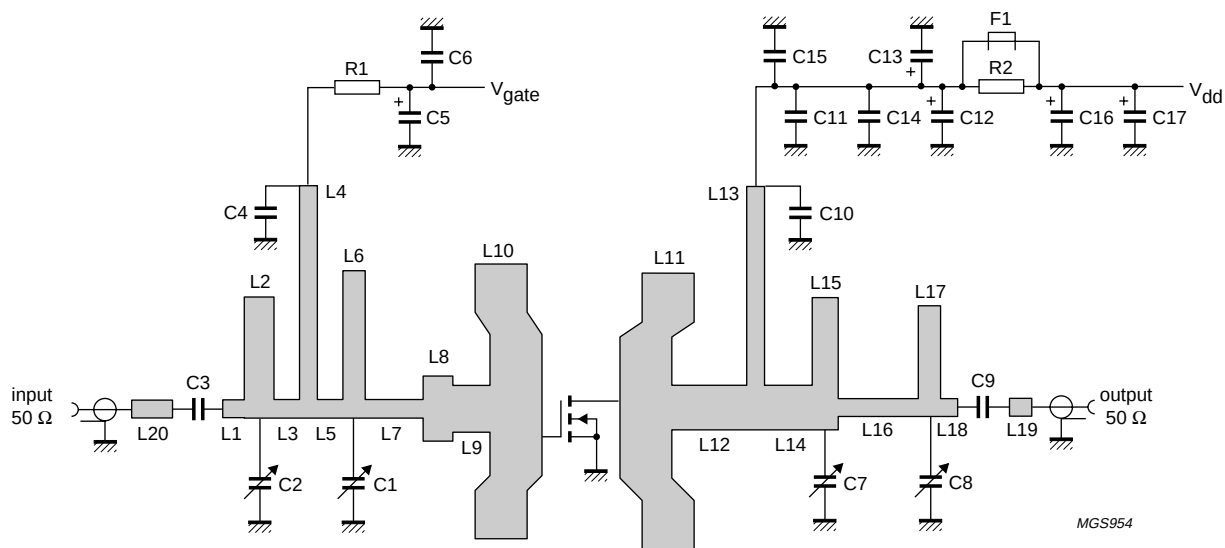


Fig.8 Class-AB test circuit at $f = 2\text{ GHz}$.

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List of components (see Figs. 8 and 9)

COMPONENT	DESCRIPTION	VALUE	DIMENSIONS	CATALOGUE NO.
C1, C2, C7 and C8	Tekelec variable capacitor; type 37271	0.6 to 4.5 pF		
C3, C9	multilayer ceramic chip capacitor; note 1	12 pF		
C4, C10	multilayer ceramic chip capacitor; note 2	12 pF		
C5, C12 and C16	electrolytic capacitor	4.5 μ F; 50 V		
C6, C11 and C15	multilayer ceramic chip capacitor; note 1	1 nF		
C13 and C17	electrolytic capacitor	100 μ F; 63 V		2222 037 58101
C14	multilayer ceramic chip capacitor	100 nF		2222 581 16641
F1	Ferroxcube chip-bead 8DS3/3/8/9-4S2			4330 030 36301
L1	stripline; note 3	50 Ω	2.9 $\times$ 2.4 mm	
L2		10.8 Ω	4 $\times$ 16.3 mm	
L3		50 Ω	3.7 $\times$ 2.4 mm	
L4		6 Ω	2 $\times$ 30.8 mm	
L5		50 Ω	3.6 $\times$ 2.4 mm	
L6		9 Ω	3 $\times$ 19.9 mm	
L7		50 Ω	7.8 $\times$ 2.4 mm	
L8		18.5 Ω	4 $\times$ 8.8 mm	
L9		24.4 Ω	5 $\times$ 6.3 mm	
L10 and L11		5.1 Ω	7 $\times$ 37 mm	
L12		25.4 Ω	10.1 $\times$ 6 mm	
L13		5.7 Ω	2.4 $\times$ 32.8 mm	
L14		25.4 Ω	6.4 $\times$ 6 mm	
L15		10 Ω	3.5 $\times$ 17.8 mm	
L16		50 Ω	10.8 $\times$ 2.4 mm	
L17		11.8 Ω	3 $\times$ 14.9 mm	
L18		50 Ω	2.3 $\times$ 2.4 mm	
L19		50 Ω	3 $\times$ 2.4 mm	
L20		50 Ω	5.5 $\times$ 2.4 mm	
R1 and R2	metal film resistor	10 Ω , 0.6 W		2322 156 11009

Notes

1. American Technical Ceramics type 100B or capacitor of same quality.
2. American Technical Ceramics type 100A or capacitor of same quality.
3. The striplines are on a double copper-clad printed-circuit board with Teflon dielectric ($\epsilon_r = 2.2$); thickness 0.79 mm.

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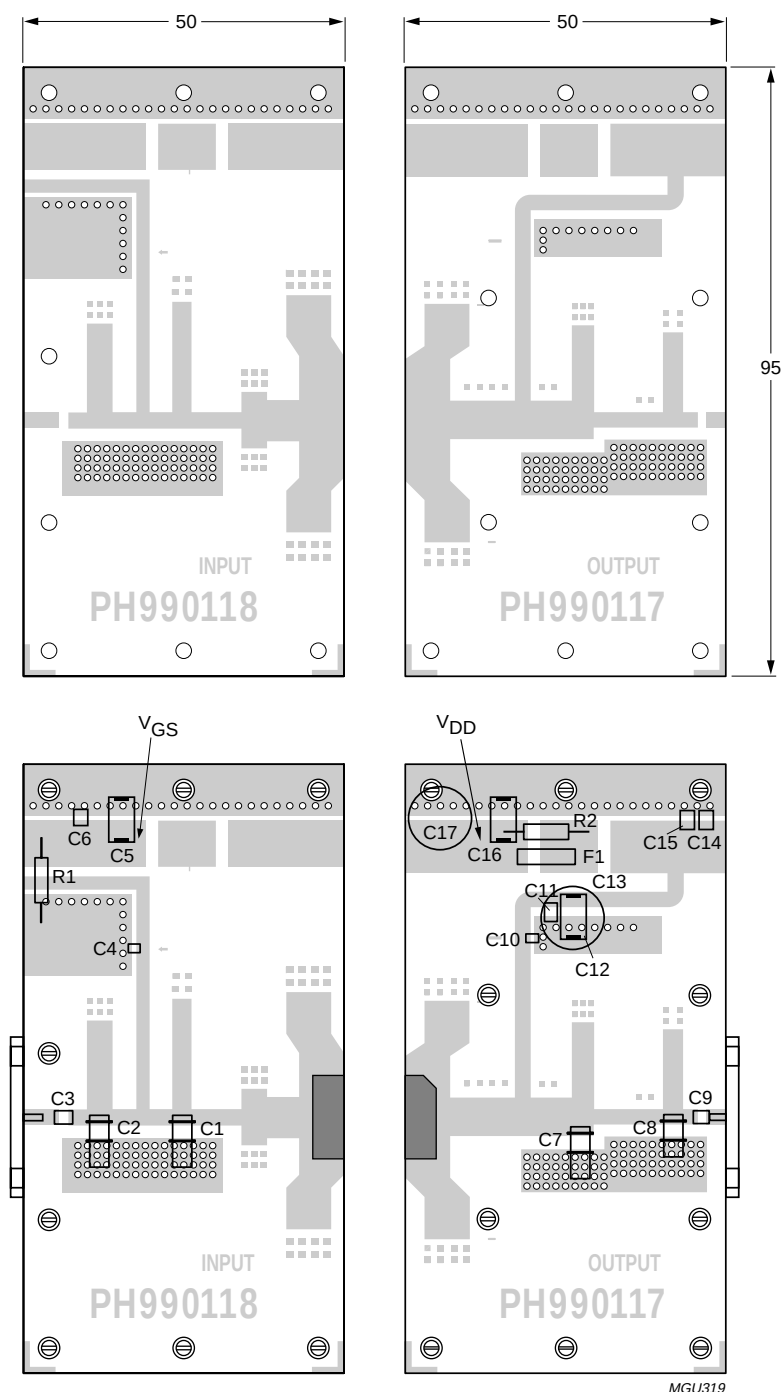


Fig.9 Component layout for 2 GHz class-AB test circuit.

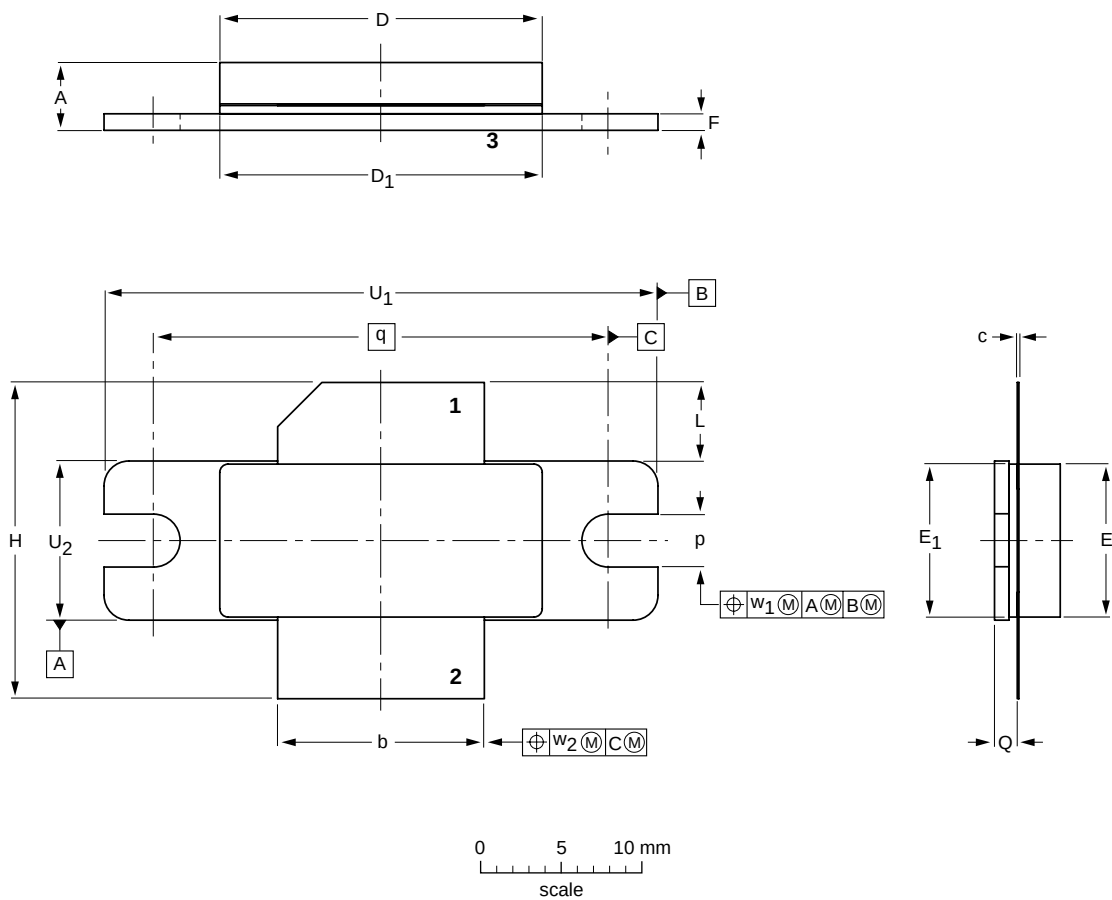
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PACKAGE OUTLINE

Flanged LDMOST ceramic package; 2 mounting holes; 2 leads

SOT502A



DIMENSIONS (millimetre dimensions are derived from the original inch dimensions)

UNIT	A	b	c	D	D ₁	E	E ₁	F	H	L	p	Q	q	U ₁	U ₂	w ₁	w ₂
mm	4.72 3.43	12.83 12.57	0.15 0.08	20.02 19.61	19.96 19.66	9.50 9.30	9.53 9.25	1.14 0.89	19.94 18.92	5.33 4.32	3.38 3.12	1.70 1.45	27.94	34.16 33.91	9.91 9.65	0.25	0.51
inches	0.186 0.135	0.505 0.495	0.006 0.003	0.788 0.772	0.786 0.774	0.374 0.366	0.375 0.364	0.045 0.035	0.785 0.745	0.210 0.170	0.133 0.123	0.067 0.057	1.100	1.345 1.335	0.390 0.380	0.01	0.02

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT502A						99-12-28 03-01-10

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DATA SHEET STATUS

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NOTES

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NOTES

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